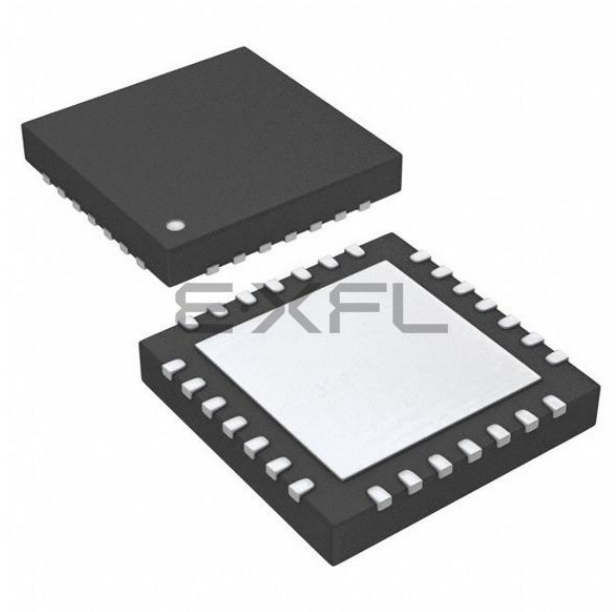

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Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	20 MIPS
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	20
Program Memory Size	12KB (4K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic30f2012-20i-ml

All byte loads into any W register are loaded into the LSB. The MSB is not modified.

A Sign-Extend (SE) instruction is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions, including the DSP instructions, operate only on words.

3.2.5 NEAR DATA SPACE

An 8 Kbyte near data space is reserved in X address memory space between 0x0000 and 0x1FFF, which is directly addressable via a 13-bit absolute address field within all memory direct instructions. The remaining X address space and all of the Y address space is addressable indirectly. Additionally, the whole of X data space is addressable using MOV instructions, which support memory direct addressing with a 16-bit address field.

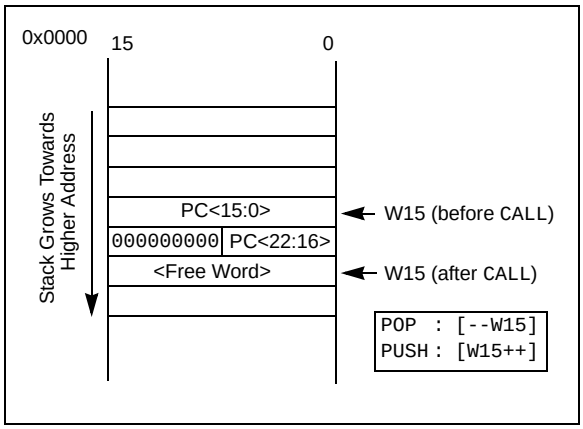
3.2.6 SOFTWARE STACK

The dsPIC DSC devices contain a software stack. W15 is used as the Stack Pointer.

The Stack Pointer always points to the first available free word and grows from lower addresses towards higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 3-10. Note that for a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

Note:	A PC push during exception processing concatenates the SRL register to the MSB of the PC prior to the push.

FIGURE 3-10: CALL STACK FRAME



There is a Stack Pointer Limit register (SPLIM) associated with the Stack Pointer. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM<0> is forced to '0' because all stack operations must be word aligned. Whenever an Effective Address (EA) is generated using W15 as a source or destination pointer, the address thus generated is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal, and a push operation is performed, a stack error trap does not occur. The stack error trap occurs on a subsequent push operation. Thus, for example, if it is desirable to cause a stack error trap when the stack grows beyond address 0x2000 in RAM, initialize the SPLIM with the value, 0x1FFE.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0x0800, thus preventing the stack from interfering with the Special Function Register (SFR) space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

TABLE 3-3: CORE REGISTER MAP (CONTINUED)

SFR Name	Address (Home)	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
CORCON	0044	—	—	—	US	EDT	DL2	DL1	DL0	SATA	SATB	SATDW	ACCSAT	IPL3	PSV	RND	IF	0000 0000 0010 0000
MODCON	0046	XMODEN	YMODEN	—	—	BWM<3:0>				YWM<3:0>				XWM<3:0>				0000 0000 0000 0000
XMODSRT	0048	XS<15:1>															0	uuuu uuuu uuuu uuu0
XMODEND	004A	XE<15:1>															1	uuuu uuuu uuuu uuu1
YMODSRT	004C	YS<15:1>															0	uuuu uuuu uuuu uuu0
YMODEND	004E	YE<15:1>															1	uuuu uuuu uuuu uuu1
XBREV	0050	BREN	XB<14:0>															uuuu uuuu uuuu uuuu
DISICNT	0052	—	—	DISICNT<13:0>														0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

5.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the "*16-bit MCU and DSC Programmer's Reference Manual*" (DS70157).

The dsPIC30F family of devices contains internal program Flash memory for executing user code. There are two methods by which the user can program this memory:

1. Run-Time Self-Programming (RTSP)
2. In-Circuit Serial Programming™ (ICSP™)

5.1 In-Circuit Serial Programming (ICSP)

dsPIC30F devices can be serially programmed while in the end application circuit. This is simply done with two lines for Programming Clock and Programming Data (which are named PGC and PGD respectively), and three other lines for Power (V_{DD}), Ground (V_{SS}) and Master Clear ($\overline{MCLR}$). This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

5.2 Run-Time Self-Programming (RTSP)

RTSP is accomplished using TBLRD (table read) and TBLWT (table write) instructions.

With RTSP, the user may erase program memory, 32 instructions (96 bytes) at a time and can write program memory data, 32 instructions (96 bytes) at a time.

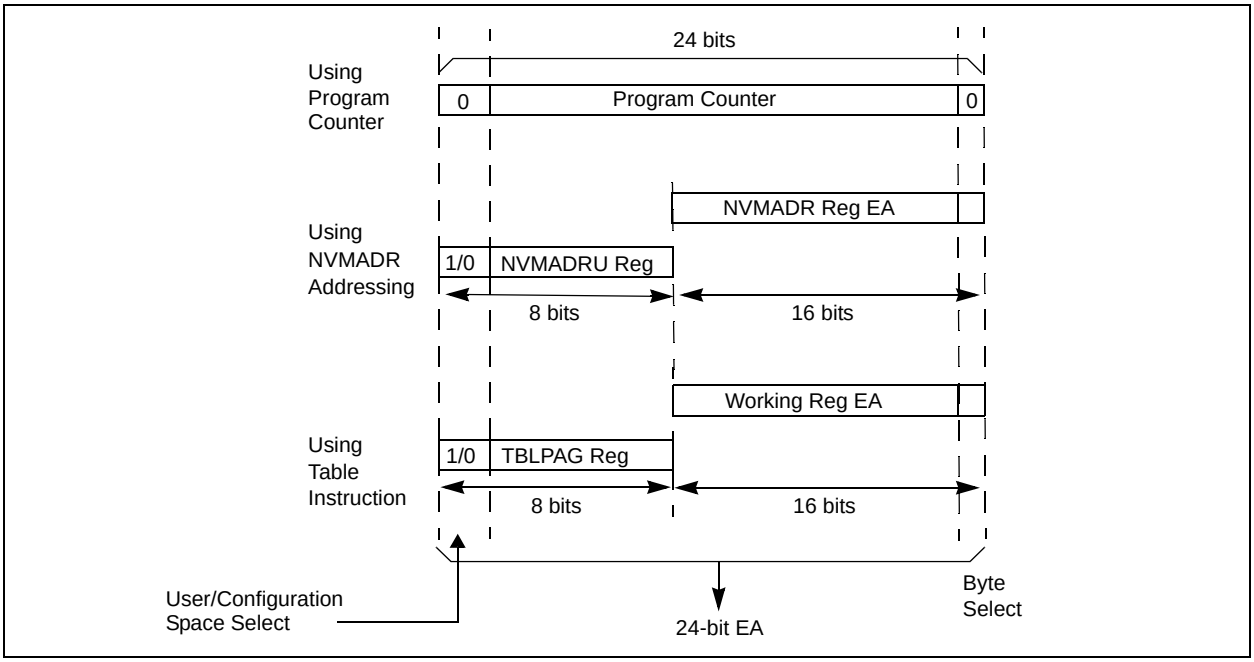
5.3 Table Instruction Operation Summary

The TBLRDL and the TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in Word or Byte mode.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can access program memory in Word or Byte mode.

A 24-bit program memory address is formed using bits<7:0> of the TBLPAG register and the Effective Address (EA) from a W register specified in the table instruction, as shown in Figure 5-1.

FIGURE 5-1: ADDRESSING FOR TABLE AND NVM REGISTERS



8.0 INTERRUPTS

Note:	This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the "*16-bit MCU and DSC Programmer's Reference Manual*" (DS70157).

The dsPIC30F sensor family has up to 21 interrupt sources and 4 processor exceptions (traps) which must be arbitrated based on a priority scheme.

The CPU is responsible for reading the Interrupt Vector Table (IVT) and transferring the address contained in the interrupt vector to the program counter. The interrupt vector is transferred from the program data bus into the program counter via a 24-bit wide multiplexer on the input of the program counter.

The Interrupt Vector Table (IVT) and Alternate Interrupt Vector Table (AIVT) are placed near the beginning of program memory (0x000004). The IVT and AIVT are shown in Figure 8-1.

The interrupt controller is responsible for pre-processing the interrupts and processor exceptions before they are presented to the processor core. The peripheral interrupts and traps are enabled, prioritized and controlled using centralized Special Function Registers (SFRs):

- IFS0<15:0>, IFS1<15:0>, IFS2<15:0>
  All interrupt request flags are maintained in these three registers. The flags are set by their respective peripherals or external signals and they are cleared via software.
- IEC0<15:0>, IEC1<15:0>, IEC2<15:0>
  All interrupt enable control bits are maintained in these three registers. These control bits are used to individually enable interrupts from the peripherals or external signals.
- IPC0<15:0> through IPC10<7:0>
  The user assignable priority level associated with each of these 41 interrupts is held centrally in these eleven registers.
- IPL<3:0>
  The current CPU priority level is explicitly stored in the IPL bits. IPL<3> is present in the CORCON register, whereas IPL<2:0> are present in the STATUS register (SR) in the processor core.
- INTCON1<15:0>, INTCON2<15:0>
  Global interrupt control functions are derived from these two registers. INTCON1 contains the control and status flags for the processor exceptions. The INTCON2 register controls the external interrupt request signal behavior and the use of the alternate vector table.

Note:	Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

All interrupt sources can be user assigned to one of 7 priority levels, 1 through 7, through the IPCx registers. Each interrupt source is associated with an interrupt vector, as shown in Table 8-1. Levels 7 and 1 represent the highest and lowest maskable priorities, respectively.

Note:	Assigning a priority level of '0' to an interrupt source is equivalent to disabling that interrupt.

If the NSTDIS bit (INTCON1<15>) is set, nesting of interrupts is prevented. Thus, if an interrupt is currently being serviced, processing of a new interrupt is prevented even if the new interrupt is of higher priority than the one currently being serviced.

Note:	The IPL bits become read-only whenever the NSTDIS bit has been set to '1'.

Certain interrupts have specialized control bits for features like edge or level triggered interrupts, interrupt-on-change, etc. Control of these features remains within the peripheral module which generates the interrupt.

The `DISI` instruction can be used to disable the processing of interrupts of priorities 6 and lower for a certain number of instructions, during which the DISI bit (INTCON2<14>) remains set.

When an interrupt is serviced, the PC is loaded with the address stored in the vector location in program memory that corresponds to the interrupt. There are 63 different vectors within the IVT (refer to Table 8-1). These vectors are contained in locations 0x000004 through 0x0000FE of program memory (refer to Table 8-1). These locations contain 24-bit addresses, and in order to preserve robustness, an address error trap takes place if the PC attempts to fetch any of these words during normal execution. This prevents execution of random data as a result of accidentally decrementing a PC into vector space, accidentally mapping a data space address into vector space, or the PC rolling over to 0x000000 after reaching the end of implemented program memory space. Execution of a `GOTO` instruction to this vector space also generates an address error trap.

8.1 Interrupt Priority

The user-assignable interrupt priority bits (IP<2:0>) for each individual interrupt source are located in the LS 3 bits of each nibble within the IPCx register(s). Bit 3 of each nibble is not used and is read as a '0'. These bits define the priority level assigned to a particular interrupt by the user.

Note: The user-assignable priority levels start at 0 as the lowest priority and level 7 as the highest priority.

Natural Order Priority is determined by the position of an interrupt in the vector table, and only affects interrupt operation when multiple interrupts with the same user-assigned priority become pending at the same time.

Table 8-1 lists the interrupt numbers and interrupt sources for the dsPIC30F2011/2012/3012/3013 devices and their associated vector numbers.

Note 1: The natural order priority scheme has 0 as the highest priority and 53 as the lowest priority.

2: The natural order priority number is the same as the INT number.

The ability for the user to assign every interrupt to one of seven priority levels means that the user can assign a very high overall priority level to an interrupt with a low natural order priority. For example, the PLVD (Low Voltage Detect) can be given a priority of 7. The INT0 (External Interrupt 0) may be assigned to priority level 1, thus giving it a very low effective priority.

TABLE 8-1: INTERRUPT VECTOR TABLE

Interrupt Number	Vector Number	Interrupt Source
Highest Natural Order Priority		
0	8	INT0 – External Interrupt 0
1	9	IC1 – Input Capture 1
2	10	OC1 – Output Compare 1
3	11	T1 – Timer 1
4	12	IC2 – Input Capture 2
5	13	OC2 – Output Compare 2
6	14	T2 – Timer2
7	15	T3 – Timer3
8	16	SPI1
9	17	U1RX – UART1 Receiver
10	18	U1TX – UART1 Transmitter
11	19	ADC – ADC Convert Done
12	20	NVM – NVM Write Complete
13	21	SI2C – I^2C™ Slave Interrupt
14	22	MI2C – I^2C Master Interrupt
15	23	Input Change Interrupt
16	24	INT1 – External Interrupt 1
17-22	25-30	Reserved
23	31	INT2 – External Interrupt 2
24	32	U2RX(1) – UART2 Receiver
25	33	U2TX(1) – UART2 Transmitter
26-41	34-49	Reserved
42	50	LVD – Low-Voltage Detect
43-53	51-61	Reserved
Lowest Natural Order Priority		

Note 1: Only the dsPIC30F3013 has UART2 and the U2RX, U2TX interrupts. These locations are reserved for the dsPIC30F2011/2012/3012.

8.2 Reset Sequence

A Reset is not a true exception because the interrupt controller is not involved in the Reset process. The processor initializes its registers in response to a Reset which forces the PC to zero. The processor then begins program execution at location 0x000000. A GOTO instruction is stored in the first program memory location immediately followed by the address target for the GOTO instruction. The processor executes the GOTO to the specified address and then begins operation at the specified target (start) address.

8.2.1 RESET SOURCES

In addition to external Reset and Power-on Reset (POR), there are six sources of error conditions which 'trap' to the Reset vector.

- Watchdog Time-out:
  The watchdog has timed out, indicating that the processor is no longer executing the correct flow of code.
- Uninitialized W Register Trap:
  An attempt to use an uninitialized W register as an Address Pointer causes a Reset.
- Illegal Instruction Trap:
  Attempted execution of any unused opcodes results in an illegal instruction trap. Note that a fetch of an illegal instruction does not result in an illegal instruction trap if that instruction is flushed prior to execution due to a flow change.
- Brown-out Reset (BOR):
  A momentary dip in the power supply to the device has been detected which may result in malfunction.
- Trap Lockout:
  Occurrence of multiple trap conditions simultaneously causes a Reset.

8.3 Traps

Traps can be considered as non-maskable interrupts indicating a software or hardware error, which adhere to a predefined priority as shown in Figure 8-1. They are intended to provide the user a means to correct erroneous operation during debug and when operating within the application.

Note:	If the user does not intend to take corrective action in the event of a trap error condition, these vectors must be loaded with the address of a default handler that contains the RESET instruction. If, on the other hand, one of the vectors containing an invalid address is called, an address error trap is generated.

Note that many of these trap conditions can only be detected when they occur. Consequently, the questionable instruction is allowed to complete prior to trap exception processing. If the user chooses to recover from the error, the result of the erroneous action that caused the trap may have to be corrected.

There are eight fixed priority levels for traps: Level 8 through Level 15, which implies that the IPL3 is always set during processing of a trap.

If the user is not currently executing a trap, and he sets the IPL<3:0> bits to a value of '0111' (Level 7), then all interrupts are disabled, but traps can still be processed.

8.3.1 TRAP SOURCES

The following traps are provided with increasing priority. However, since all traps can be nested, priority has little effect.

Math Error Trap:

The math error trap executes under the following four circumstances:

1. If an attempt is made to divide by zero, the divide operation is aborted on a cycle boundary and the trap is taken.
2. If enabled, a math error trap is taken when an arithmetic operation on either accumulator A or B causes an overflow from bit 31 and the accumulator guard bits are not utilized.
3. If enabled, a math error trap is taken when an arithmetic operation on either accumulator A or B causes a catastrophic overflow from bit 39 and all saturation is disabled.
4. If the shift amount specified in a shift instruction is greater than the maximum allowed shift amount, a trap occurs.

TABLE 8-3: dsPIC30F3013 INTERRUPT CONTROLLER REGISTER MAP

SFR Name	ADR	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
INTCON1	0080	NSTDIS	—	—	—	—	OVATE	OVBTE	COVTE	—	—	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—	0000 0000 0000 0000
INTCON2	0082	ALTIVT	DISI	—	—	—	—	—	—	—	—	—	—	—	INT2EP	INT1EP	INT0EP	0000 0000 0000 0000
IFS0	0084	CNIF	MI2CIF	SI2CIF	NVMIF	ADIF	U1TXIF	U1RXIF	SPI1IF	T3IF	T2IF	OC2IF	IC2IF	T1IF	OC1IF	IC1IF	INT0IF	0000 0000 0000 0000
IFS1	0086	—	—	—	—	—	—	U2TXIF	U2RXIF	INT2IF	—	—	—	—	—	—	INT1IF	0000 0000 0000 0000
IFS2	0088	—	—	—	—	—	LVDIF	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IEC0	008C	CNIE	MI2CIE	SI2CIE	NVMIE	ADIE	U1TXIE	U1RXIE	SPI1IE	T3IE	T2IE	OC2IE	IC2IE	T1IE	OC1IE	IC1IE	INT0IE	0000 0000 0000 0000
IEC1	008E	—	—	—	—	—		U2TXIE	U2RXIE	INT2IE	—	—	—	—	—	—	INT1IE	0000 0000 0000 0000
IEC2	0090	—	—	—	—	—	LVDIE	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC0	0094	—	T1IP<2:0>			—	OC1IP<2:0>			—	IC1IP<2:0>			—	INT0IP<2:0>			0100 0100 0100 0100
IPC1	0096	—	T31P<2:0>			—	T2IP<2:0>			—	OC2IP<2:0>			—	IC2IP<2:0>			0100 0100 0100 0100
IPC2	0098	—	ADIP<2:0>			—	U1TXIP<2:0>			—	U1RXIP<2:0>			—	SPI1IP<2:0>			0100 0100 0100 0100
IPC3	009A	—	CNIP<2:0>			—	MI2CIP<2:0>			—	SI2CIP<2:0>			—	NVMIP<2:0>			0100 0100 0100 0100
IPC4	009C	—	—	—	—	—	—	—	—	—	—	—	—	—	INT1IP<2:0>			0000 0000 0000 0100
IPC5	009E	—	INT2IP<2:0>			—	—	—	—	—	—	—	—	—				0100 0000 0000 0000
IPC6	00A0	—	—	—	—	—	—	—	—	—	U2TXIP<2:0>			—	U2RXIP<2:0>			0000 0000 0100 0100
IPC7	00A2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC8	00A4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC9	00A6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC10	00A8	—	—	—	—	—	LVDIP<2:0>			—	—	—	—	—	—	—	—	0000 0100 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

Enabling an interrupt is accomplished via the respective timer interrupt enable bit, T1IE. The timer interrupt enable bit is located in the IEC0 Control register in the interrupt controller.

TABLE 10-1: TIMER2/3 REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TMR2	0106	Timer2 Register																uuuu uuuu uuuu uuuu
TMR3HLD	0108	Timer3 Holding Register (for 32-bit timer operations only)																uuuu uuuu uuuu uuuu
TMR3	010A	Timer3 Register																uuuu uuuu uuuu uuuu
PR2	010C	Period Register 2																1111 1111 1111 1111
PR3	010E	Period Register 3																1111 1111 1111 1111
T2CON	0110	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T32	—	TCS	—	0000 0000 0000 0000
T3CON	0112	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

16.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (ADC) MODULE

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046).

The 12-bit Analog-to-Digital Converter allows conversion of an analog input signal to a 12-bit digital number. This module is based on a Successive Approximation Register (SAR) architecture and provides a maximum sampling rate of 200 ksps. The ADC module has up to 10 analog inputs which are multiplexed into a sample and hold amplifier. The output of the sample and hold is the input into the converter which generates the result. The analog reference voltage is software selectable to either the device supply voltage (AVDD/AVSS) or the voltage level on the (VREF+/VREF-) pin. The ADC has a unique feature of being able to operate while the device is in Sleep mode with RC oscillator selection.

The ADC module has six 16-bit registers:

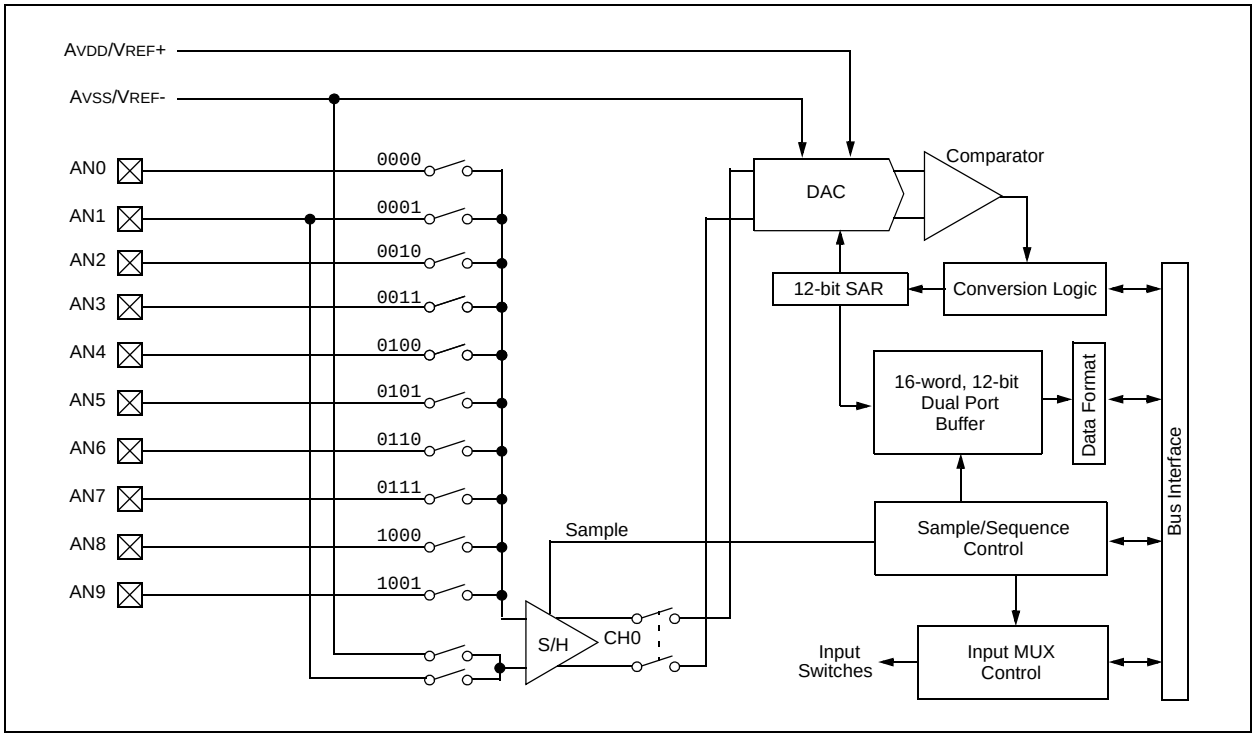
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)
- A/D Control Register 3 (ADCON3)
- A/D Input Select Register (ADCHS)
- A/D Port Configuration Register (ADPCFG)
- A/D Input Scan Selection Register (ADCSSL)

The ADCON1, ADCON2 and ADCON3 registers control the operation of the ADC module. The ADCHS register selects the input channels to be converted. The ADPCFG register configures the port pins as analog inputs or as digital I/O. The ADCSSL register selects inputs for scanning.

Note: The SSRC<2:0>, ASAM, SMPI<3:0>, BUFM and ALTS bits, as well as the ADCON3 and ADCSSL registers, must not be written to while ADON = 1. This would lead to indeterminate results.

The block diagram of the 12-bit ADC module is shown in Figure 16-1.

FIGURE 16-1: 12-BIT ADC FUNCTIONAL BLOCK DIAGRAM

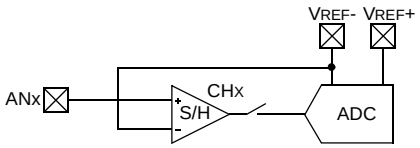
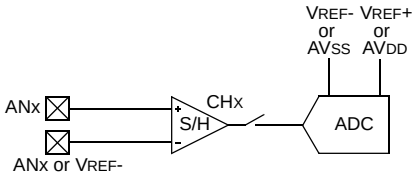


16.7 ADC Speeds

The dsPIC30F 12-bit ADC specifications permit a maximum of 200 ksps sampling rate. Table 16-1 summarizes the conversion speeds for the dsPIC30F 12-bit ADC and the required operating conditions.

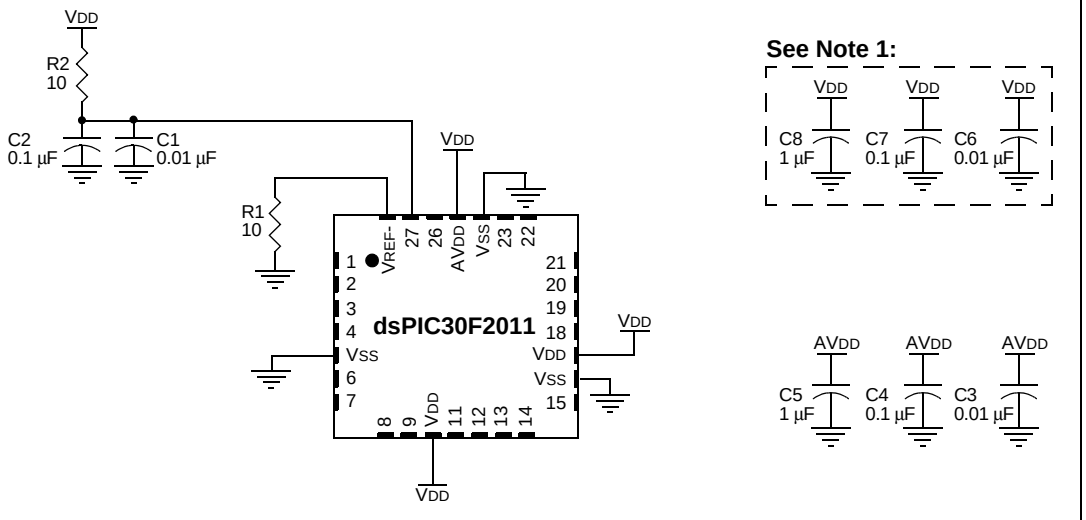
Figure 16-2 depicts the recommended circuit for the conversion rates above 200 ksps. The dsPIC30F2011 is shown as an example.

TABLE 16-1: 12-BIT ADC EXTENDED CONVERSION RATES

dsPIC30F 12-bit ADC Conversion Rates						
Speed	**TAD Minimum**	**Sampling Time Min**	**R_S Max**	**VDD**	**Temperature**	**Channel Configuration**
Up to 200 ksps(1)	334 ns	1 TAD	2.5 kΩ	4.5V to 5.5V	-40°C to +85°C	
Up to 100 ksps	668 ns	1 TAD	2.5 kΩ	3.0V to 5.5V	-40°C to +125°C	

Note 1: External VREF- and VREF+ pins must be used for correct operation. See Figure 16-2 for recommended circuit.

FIGURE 16-2: ADC VOLTAGE REFERENCE SCHEMATIC



Note 1: Ensure adequate bypass capacitors are provided on each VDD pin.

TABLE 17-1: OSCILLATOR OPERATING MODES

Oscillator Mode	Description
XTL	200 kHz-4 MHz crystal on OSC1:OSC2.
XT	4 MHz-10 MHz crystal on OSC1:OSC2.
XT w/PLL 4x	4 MHz-10 MHz crystal on OSC1:OSC2, 4x PLL enabled.
XT w/PLL 8x	4 MHz-10 MHz crystal on OSC1:OSC2, 8x PLL enabled.
XT w/PLL 16x	4 MHz-7.5 MHz crystal on OSC1:OSC2, 16x PLL enabled(1).
LP	32 kHz crystal on SOSCO:SOSCI(2).
HS	10 MHz-25 MHz crystal.
HS/2 w/PLL 4x	10 MHz-20 MHz crystal, divide by 2, 4x PLL enabled.
HS/2 w/PLL 8x	10 MHz-20 MHz crystal, divide by 2, 8x PLL enabled.
HS/2 w/PLL 16x	10 MHz-15 MHz crystal, divide by 2, 16x PLL enabled(1).
HS/3 w/PLL 4x	12 MHz-25 MHz crystal, divide by 3, 4x PLL enabled.
HS/3 w/PLL 8x	12 MHz-25 MHz crystal, divide by 3, 8x PLL enabled.
HS/3 w/PLL 16x	12 MHz-22.5 MHz crystal, divide by 3, 16x PLL enabled(1).
EC	External clock input (0-40 MHz).
ECIO	External clock input (0-40 MHz), OSC2 pin is I/O.
EC w/PLL 4x	External clock input (4-10 MHz), OSC2 pin is I/O, 4x PLL enabled.
EC w/PLL 8x	External clock input (4-10 MHz), OSC2 pin is I/O, 8x PLL enabled.
EC w/PLL 16x	External clock input (4-7.5 MHz), OSC2 pin is I/O, 16x PLL enabled(1).
ERC	External RC oscillator, OSC2 pin is FOSC/4 output(3).
ERCIO	External RC oscillator, OSC2 pin is I/O(3).
FRC	7.37 MHz internal RC oscillator.
FRC w/PLL 4x	7.37 MHz Internal RC oscillator, 4x PLL enabled.
FRC w/PLL 8x	7.37 MHz Internal RC oscillator, 8x PLL enabled.
FRC w/PLL 16x	7.37 MHz Internal RC oscillator, 16x PLL enabled.
LPRC	512 kHz internal RC oscillator.

Note 1: dsPIC30F maximum operating frequency of 120 MHz must be met.

2: LP oscillator can be conveniently shared as system clock, as well as real-time clock for Timer1.

3: Requires external R and C. Frequency operation up to 4 MHz.

17.3.1.1 POR with Long Crystal Start-up Time (with FSCM Enabled)

The oscillator start-up circuitry is not linked to the POR circuitry. Some crystal circuits (especially low frequency crystals) will have a relatively long start-up time. Therefore, one or more of the following conditions is possible after the POR timer and the PWRT have expired:

- The oscillator circuit has not begun to oscillate.
- The Oscillator Start-up Timer has not expired (if a crystal oscillator is used).
- The PLL has not achieved a LOCK (if PLL is used).

If the FSCM is enabled and one of the above conditions is true, then a clock failure trap will occur. The device will automatically switch to the FRC oscillator and the user can switch to the desired crystal oscillator in the trap ISR.

17.3.1.2 Operating without FSCM and PWRT

If the FSCM is disabled and the Power-up Timer (PWRT) is also disabled, then the device will exit rapidly from Reset on power-up. If the clock source is FRC, LPRC, ERC or EC, it will be active immediately.

If the FSCM is disabled and the system clock has not started, the device will be in a frozen state at the Reset vector until the system clock starts. From the user's perspective, the device will appear to be in Reset until a system clock is available.

17.3.2 BOR: PROGRAMMABLE BROWN-OUT RESET

The BOR (Brown-out Reset) module is based on an internal voltage reference circuit. The main purpose of the BOR module is to generate a device Reset when a brown-out condition occurs. Brown-out conditions are generally caused by glitches on the AC mains (i.e., missing portions of the AC cycle waveform due to bad power transmission lines, or voltage sags due to excessive current draw when a large inductive load is turned on).

The BOR module allows selection of one of the following voltage trip points (see Table 20-11):

- 2.6V-2.71V
- 4.1V-4.4V
- 4.58V-4.73V

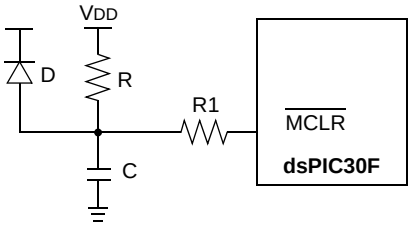
Note:	The BOR voltage trip points indicated here are nominal values provided for design guidance only. Refer to the Electrical Specifications in the specific device data sheet for BOR voltage limit specifications.

A BOR will generate a Reset pulse which will reset the device. The BOR will select the clock source based on the device Configuration bit values (FOS<2:0> and FPR<4:0>). Furthermore, if an Oscillator mode is selected, the BOR will activate the Oscillator Start-up Timer (OST). The system clock is held until OST expires. If the PLL is used, then the clock will be held until the LOCK bit (OSCCON<5>) is '1'.

Concurrently, the POR time-out (T_{POR}) and the PWRT time-out (T_{PWRT}) will be applied before the internal Reset is released. If T_{PWRT} = 0 and a crystal oscillator is being used, then a nominal delay of T_{FSCM} = 100 µs is applied. The total delay in this case is (T_{POR} + T_{FSCM}).

The BOR Status bit (RCON<1>) will be set to indicate that a BOR has occurred. The BOR circuit, if enabled, will continue to operate while in Sleep or Idle modes and will reset the device should V_{DD} fall below the BOR threshold voltage.

FIGURE 17-6: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW V_{DD} POWER-UP)



Note 1: External Power-on Reset circuit is required only if the V_{DD} power-up slope is too slow. The diode D helps discharge the capacitor quickly when V_{DD} powers down.

2: R should be suitably chosen so as to make sure that the voltage drop across R does not violate the device's electrical specifications.

3: R1 should be suitably chosen so as to limit any current flowing into $\overline{MCLR}$ from external capacitor C, in the event of $\overline{MCLR}/V_{PP}$ pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

Note:	Dedicated supervisory devices, such as the MCP1XX and MCP8XX, may also be used as an external Power-on Reset circuit.

Any interrupt that is individually enabled (using the corresponding IE bit) and meets the prevailing priority level will be able to wake-up the processor. The processor will process the interrupt and branch to the ISR. The Sleep Status bit in the RCON register is set upon wake-up.

Note:	In spite of various delays applied (TPOR, TLOCK and TPWRT), the crystal oscillator (and PLL) may not be active at the end of the time-out (e.g., for low-frequency crystals). In such cases, if FSCM is enabled, then the device will detect this as a clock failure and process the clock failure trap, the FRC oscillator will be enabled and the user will have to re-enable the crystal oscillator. If FSCM is not enabled, then the device will simply suspend execution of code until the clock is stable and will remain in Sleep until the oscillator clock has started.

All Resets will wake-up the processor from Sleep mode. Any Reset, other than POR, will set the Sleep Status bit. In a POR, the Sleep bit is cleared.

If the Watchdog Timer is enabled, then the processor will wake-up from Sleep mode upon WDT time-out. The Sleep and WDTO Status bits are both set.

17.6.2 IDLE MODE

In Idle mode, the clock to the CPU is shut down while peripherals keep running. Unlike Sleep mode, the clock source remains active.

Several peripherals have a control bit in each module that allows them to operate during Idle.

LPRC Fail-Safe Clock remains active if clock failure detect is enabled.

The processor wakes up from Idle if at least one of the following conditions has occurred:

- any interrupt that is individually enabled (IE bit is '1') and meets the required priority level
- any Reset (POR, BOR, $\overline{\text{MCLR}}$)
- WDT time-out

Upon wake-up from Idle mode, the clock is re-applied to the CPU and instruction execution begins immediately, starting with the instruction following the PWRSAV instruction.

Any interrupt that is individually enabled (using IE bit) and meets the prevailing priority level will be able to wake-up the processor. The processor will process the interrupt and branch to the ISR. The Idle Status bit in the RCON register is set upon wake-up.

Any Reset other than POR will set the Idle Status bit. On a POR, the Idle bit is cleared.

If Watchdog Timer is enabled, then the processor will wake-up from Idle mode upon WDT time-out. The Idle and WDTO Status bits are both set.

Unlike wake-up from Sleep, there are no time delays involved in wake-up from Idle.

17.7 Device Configuration Registers

The Configuration bits in each device Configuration register specify some of the device modes and are programmed by a device programmer, or by using the In-Circuit Serial Programming™ (ICSP™) feature of the device. Each device Configuration register is a 24-bit register, but only the lower 16 bits of each register are used to hold configuration data. There are five device Configuration registers available to the user:

1. FOSC (0xF80000): Oscillator Configuration Register
2. FWDT (0xF80002): Watchdog Timer Configuration Register
3. FBORPOR (0xF80004): BOR and POR Configuration Register
4. FGS (0xF8000A): General Code Segment Configuration Register
5. FICD (0xF8000C): Debug Configuration Register

The placement of the Configuration bits is automatically handled when you select the device in your device programmer. The desired state of the Configuration bits may be specified in the source code (dependent on the language tool used), or through the programming interface. After the device has been programmed, the application software may read the Configuration bit values through the table read instructions. For additional information, please refer to the Programming Specifications of the device.

Note:	If the code protection Configuration fuse bits (FGS<GCP> and FGS<GWRP>) have been programmed, an erase of the entire code-protected device is only possible at voltages $V_{DD} \geq 4.5V$.

TABLE 17-7: SYSTEM INTEGRATION REGISTER MAP

SFR Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
RCON	0740	TRAPR	IOPUWR	BGST	LVDEN	LVDL<3:0>				EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	—	COSC<2:0>			—	NOSC<2:0>			POST<1:0>		LOCK	—	CF	—	LPOSCEN	OSWEN	(Note 2)
OSCTUN	0744	—	—	—	—	—	—	—	—	—	—	—	—	TUN3	TUN2	TUN1	TUN0	(Note 2)
PMD1	0770	—	—	T3MD	T2MD	T1MD	—	—	—	I2CMD	U2MD(3)	U1MD	—	SPI1MD	—	—	ADCMD	0000 0000 0000 0000
PMD2	0772	—	—	—	—	—	—	IC2MD	IC1MD	—	—	—	—	—	—	OC2MD	OC1MD	0000 0000 0000 0000

Legend: — = unimplemented bit, read as '0'

Note 1: Reset state depends on type of reset.

2: Reset state depends on Configuration bits.

3: Only available on dsPIC30F3013 devices.

TABLE 17-8: DEVICE CONFIGURATION REGISTER MAP

Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FOSC	F80000	FCKSM<1:0>		—	—	—	FOS<2:0>			—	—	—	FPR<4:0>				
FWDT	F80002	FWDTEN	—	—	—	—	—	—	—	—	—	FWPSA<1:0>		FWPSB<3:0>			
FBORPOR	F80004	MCLREN	—	—	—	—	PWMPIN(1)	HPOL(1)	LPOL(1)	BOREN	—	BORV<1:0>		—	—	FPWRT<1:0>	
FBS	F80006	—	—	Reserved(2)		—	—	—	Reserved(2)	—	—	—	—	Reserved(2)			
FSS	F80008	—	—	Reserved(2)		—	—	Reserved(2)		—	—	—	—	Reserved(2)			
FGS	F8000A	—	—	—	—	—	—	—	—	—	—	—	—	—	Reserved(3)	GCP	GWRP
FICD	F8000C	BKBUG	COE	—	—	—	—	—	—	—	—	—	—	—	—	ICS<1:0>	

Legend: — = unimplemented bit, read as '0'

Note 1: These bits are reserved (read as '1' and must be programmed as '1').

2: Reserved bits read as '1' and must be programmed as '1'.

3: The FGS<2> bit is a read-only copy of the GCP bit (FGS<1>).

18.0 INSTRUCTION SET SUMMARY

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the "*dsPIC30F Programmer's Reference Manual*" (DS70030).

The dsPIC30F instruction set adds many enhancements to the previous PIC® MCU instruction sets, while maintaining an easy migration from PIC MCU instruction sets.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode which specifies the instruction type, and one or more operands which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- Literal operations
- DSP operations
- Control operations

Table 18-1 shows the general symbols used in describing the instructions.

The dsPIC30F instruction set summary in Table 18-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand which is typically a register 'Wb' without any address modifier
- The second source operand which is typically a register 'Ws' with or without an address modifier
- The destination of the result which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value 'f'
- The destination, which could either be the file register 'f' or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand which is a register 'Wb' without any address modifier
- The second source operand which is a literal value
- The destination of the result (only if not the same as the first source operand) which is typically a register 'Wd' with or without an address modifier

The MAC class of DSP instructions may use some of the following operands:

- The accumulator (A or B) to be used (required operand)
- The W registers to be used as the two operands
- The X and Y address space prefetch operations
- The X and Y address space prefetch destinations
- The accumulator write-back destination

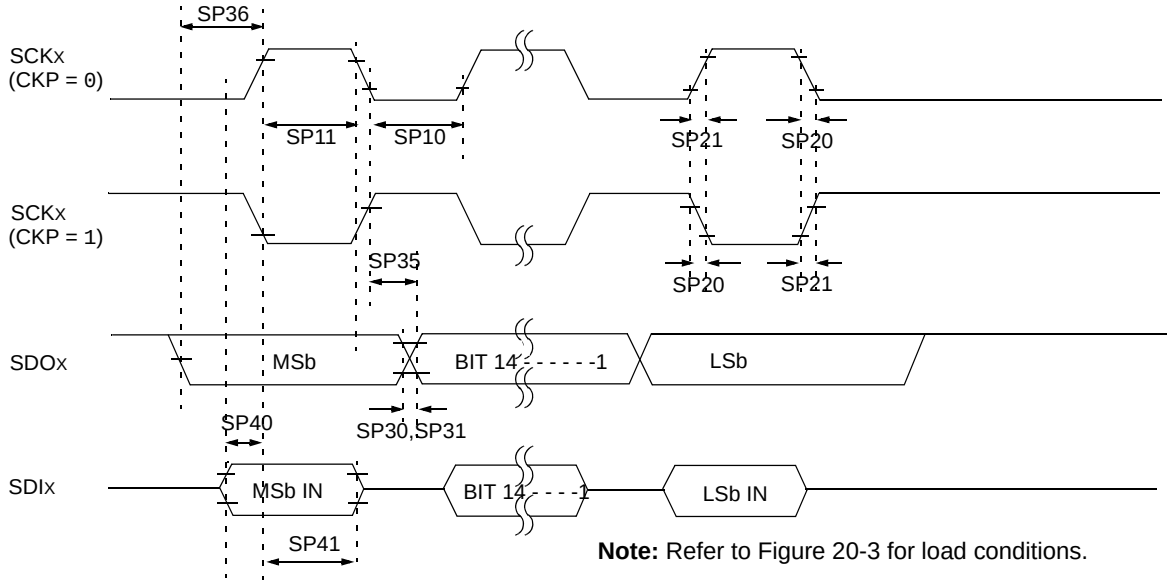
The other DSP instructions do not involve any multiplication, and may include:

- The accumulator to be used (required)
- The source or destination operand (designated as Wso or Wdo, respectively) with or without an address modifier
- The amount of shift specified by a W register 'Wn' or a literal value

The control instructions may use some of the following operands:

- A program memory address
- The mode of the table read and table write instructions

FIGURE 20-13: SPI MODULE MASTER MODE (CKE =1) TIMING CHARACTERISTICS



Note: Refer to Figure 20-3 for load conditions.

TABLE 20-30: SPI MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SP10	TscL	SCKx output low time(3)	TCY/2	—	—	ns	—
SP11	TscH	SCKx output high time(3)	TCY/2	—	—	ns	—
SP20	TscF	SCKx output fall time(4)	—	—	—	ns	See parameter DO32
SP21	TscR	SCKx output rise time(4)	—	—	—	ns	See parameter DO31
SP30	TdoF	SDOx data output fall time(4)	—	—	—	ns	See parameter DO32
SP31	TdoR	SDOx data output rise time(4)	—	—	—	ns	See parameter DO31
SP35	TscH2doV, TscL2doV	SDOx data output valid after SCKx edge	—	—	30	ns	—
SP36	TdoV2sc, TdoV2scL	SDOx data output setup to first SCKx edge	30	—	—	ns	—
SP40	TdiV2scH, TdiV2scL	Setup time of SDIx data input to SCKx edge	20	—	—	ns	—
SP41	TscH2diL, TscL2diL	Hold time of SDIx data input to SCKx edge	20	—	—	ns	—

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in “Typ” column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCK is 100 ns. Therefore, the clock generated in master mode must not violate this specification.

4: Assumes 50 pF load on all SPI pins.

TABLE 20-32: SPI MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SP70	TscL	SCKx Input Low Time	30	—	—	ns	—
SP71	TscH	SCKx Input High Time	30	—	—	ns	—
SP72	TscF	SCKx Input Fall Time(3)	—	10	25	ns	—
SP73	TscR	SCKx Input Rise Time(3)	—	10	25	ns	—
SP30	TdoF	SDOx Data Output Fall Time(3)	—	—	—	ns	See parameter DO32
SP31	TdoR	SDOx Data Output Rise Time(3)	—	—	—	ns	See parameter DO31
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	—	30	ns	—
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	20	—	—	ns	—
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	20	—	—	ns	—
SP50	TssL2scH, TssL2scL	$\overline{SS}$x↓to SCKx↓or SCKx↑ input	120	—	—	ns	—
SP51	TssH2doZ	$\overline{SS}$↑ to SDOx Output high impedance(4)	10	—	50	ns	—
SP52	TscH2ssH TscL2ssH	$\overline{SS}$x↑ after SCKx Edge	1.5 TCY + 40	—	—	ns	—
SP60	TssL2doV	SDOx Data Output Valid after SCKx Edge	—	—	50	ns	—

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ" column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCK is 100 ns. Therefore, the clock generated in Master mode must not violate this specification.

4: Assumes 50 pF load on all SPI pins.

FIGURE 20-18: I²C™ BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)

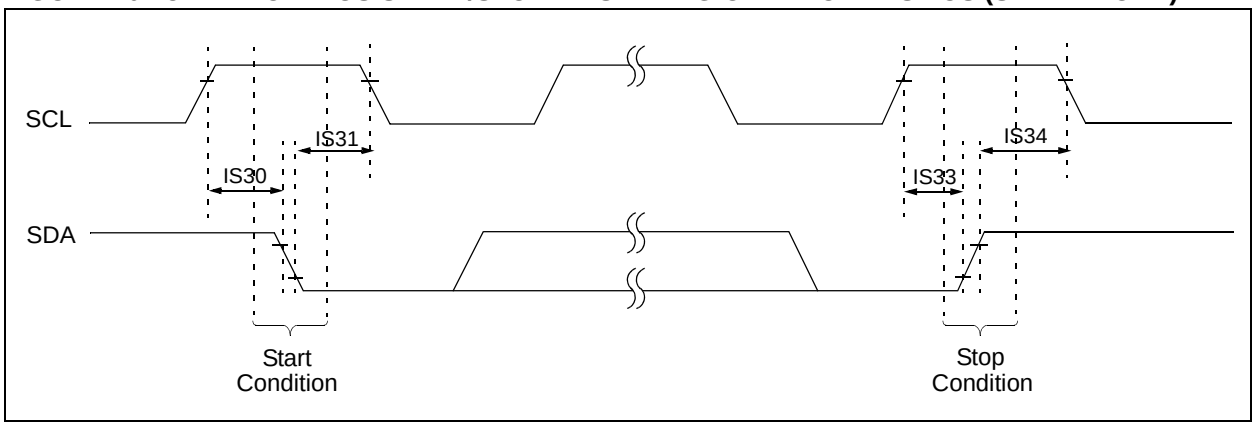


FIGURE 20-19: I²C™ BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)

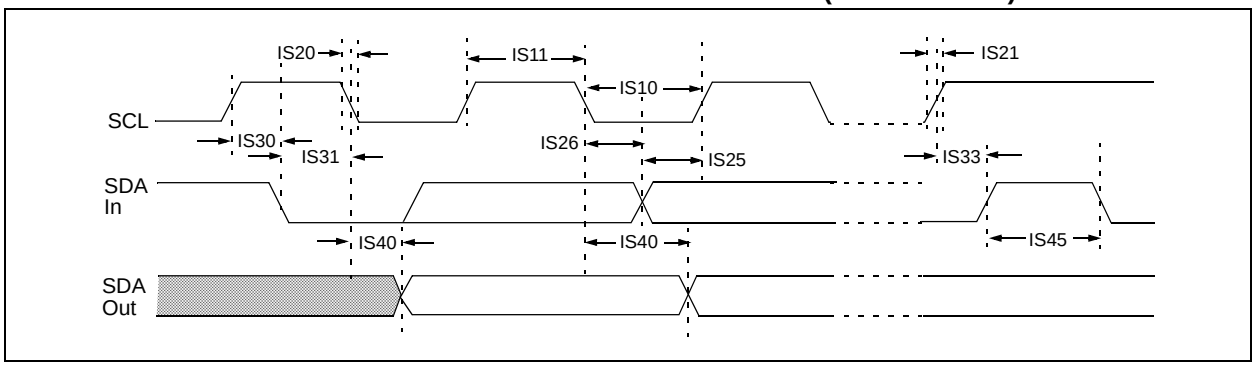


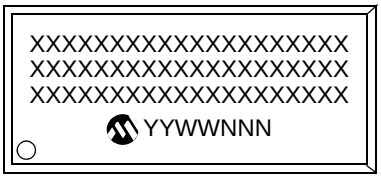
TABLE 20-34: I²C™ BUS DATA TIMING REQUIREMENTS (SLAVE MODE)

AC CHARACTERISTICS			**Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated)** Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic**		**Min**	**Max**	**Units**	**Conditions**
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	—	µs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	—	µs	Device must operate at a minimum of 10 MHz.
			1 MHz mode(1)	0.5	—	µs	
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0	—	µs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	—	µs	Device must operate at a minimum of 10 MHz
			1 MHz mode(1)	0.5	—	µs	
IS20	TF:SCL	SDA and SCL Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	100	ns	
IS21	TR:SCL	SDA and SCL Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	300	ns	

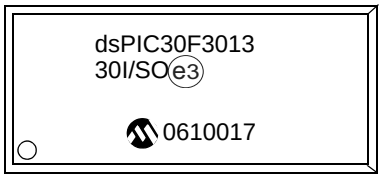
Note 1: Maximum pin capacitance = 10 pF for all I²C™ pins (for 1 MHz mode only).

21.2 Package Marking Information (Continued)

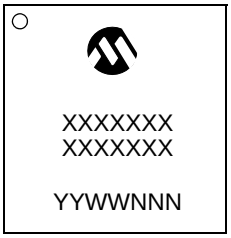
28-Lead SOIC



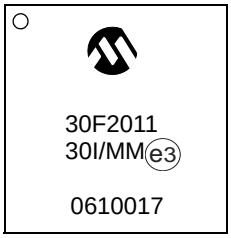
Example



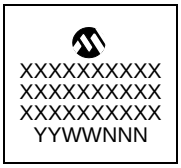
28-Lead QFN-S



Example



44-Lead QFN



Example